## Silicon Epitaxial Trench Pin Diode for Antenna Switching

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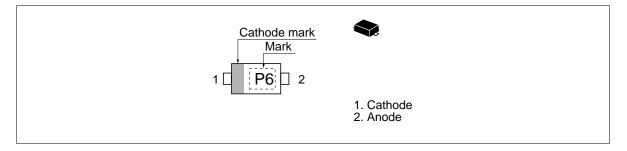
#### Features

- Adopting the trench structure improves low capacitance.(C = 0.45 pF max)
- Low forward resistance. ( $rf = 2.5\Omega max$ )
- Low operation current.
- Ultra small Flat Package (UFP) is suitable for surface mount design and stable rf characteristics in high frequency.

#### **Ordering Information**

Туре No.	Laser Mark	Package Code
HVC136	P6	UFP

#### Outline





## Absolute Maximum Ratings (Ta = $25^{\circ}$ C)

Item	Symbol	Value	Unit
Peak reverse voltage	V <sub>RM</sub>	65	V
Reverse voltage	V <sub>R</sub>	60	V
Forward current	I <sub>F</sub>	100	mA
Power dissipation	P <sub>d</sub>	150	mW
Junction temperature	Тј	125	°C
Storage temperature	Tstg	-55 to +125	°C

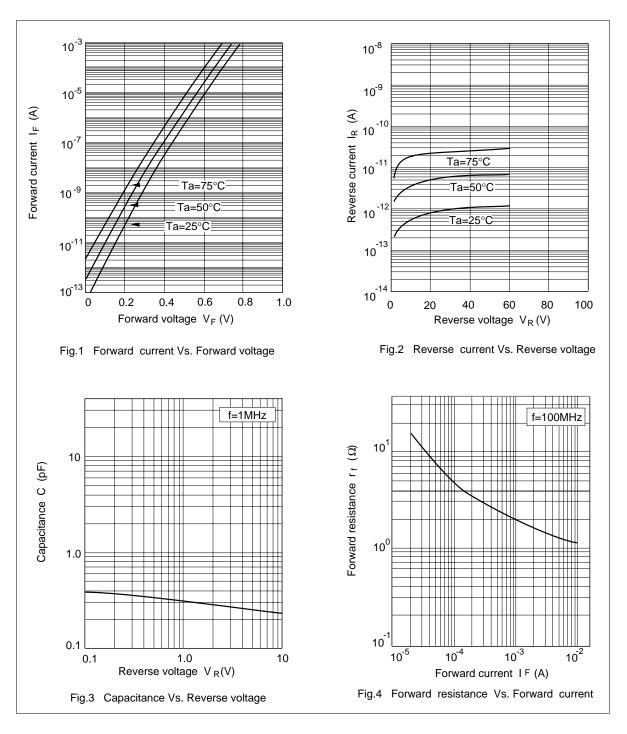
### **Electrical Characteristics** (Ta = $25^{\circ}$ C)

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R</sub>		_	0.1	μΑ	$V_{R} = 60V$
Forward voltage	V <sub>F</sub>		—	0.9	V	$I_F = 2 \text{ mA}$
Capacitance	С		—	0.45	pF	$V_R = 1V$ , f = 1 MHz
Forward resistance	r <sub>f</sub>		—	2.5	Ω	I <sub>F</sub> = 2mA, f = 100 MHz
ESD-Capability <sup>*1</sup>	—	100	—	—	V	C = 200pF , Both forward and reverse direction 1 pulse.

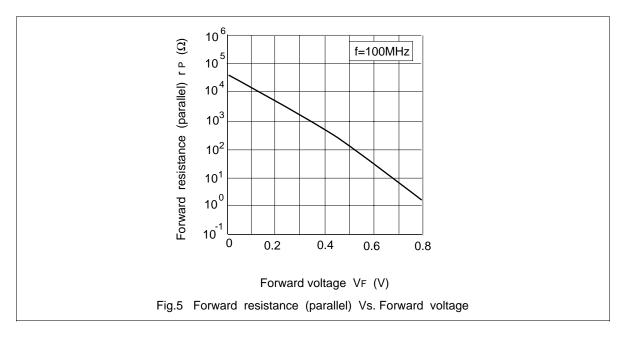
Note : 1. Failure criterion ; IR > 100nA at VR =60 V

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#### **Main Characteristic**

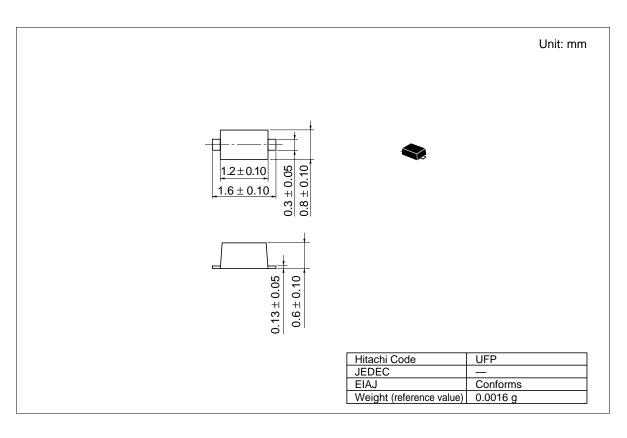


#### **Main Characteristic**



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## **Package Dimensions**



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